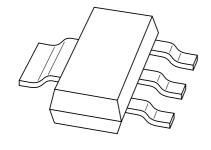
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS4540Z40 V low V_{CEsat} NPN transistor

Product data sheet Supersedes data of 2001 Jul 24 2001 Nov 14



40 V low V_{CEsat} NPN transistor

PBSS4540Z

FEATURES

- Low collector-emitter saturation voltage
- · High current capabilities
- Improved device reliability due to reduced heat generation.

APPLICATIONS

- Supply line switching circuits
- · Battery management applications
- DC/DC converter applications
- · Strobe flash units
- Heavy duty battery powered equipment (motor and lamp drivers)
- MOSFET driver applications.

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT223 plastic package. PNP complement: PBSS5540Z.

MARKING

| TYPE NUMBER | MARKING CODE |
|-------------|--------------|
| PBSS4540Z | PB4540 |

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX | UNIT |
|--------------------|---------------------------|-----|------|
| V _{CEO} | emitter-collector voltage | 40 | V |
| I _C | collector current (DC) | 5 | Α |
| I _{CM} | peak collector current | 10 | Α |
| R _{CEsat} | equivalent on-resistance | <71 | mΩ |

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | collector |
| 3 | emitter |
| 4 | collector |

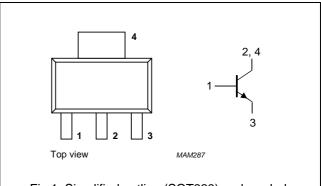


Fig.1 Simplified outline (SOT223) and symbol.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|---|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | 40 | V |
| V _{CEO} | collector-emitter voltage | open base | _ | 40 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | 6 | V |
| I _C | collector current (DC) | | _ | 5 | Α |
| I _{CM} | peak collector current | | - | 10 | Α |
| I _{BM} | peak base current | | _ | 2 | Α |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; notes 1 and 3 | _ | 1.35 | W |
| | | T _{amb} ≤ 25 °C; notes 2 and 3 | - | 2 | W |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 6 cm².
- 3. For other mounting conditions, see "Thermal considerations for SOT223 in the General Part of associated Handbook".

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------------|-------------------------------------|------------|-------|------|
| R _{th j-a} | thermal resistance from junction to | note 1 | 92 | K/W |
| | ambient | note 2 | 62.5 | K/W |

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 6 cm².

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

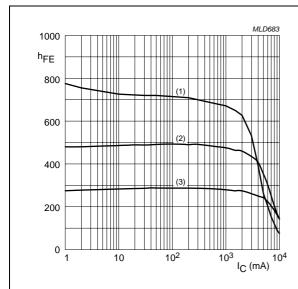
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|--------------------------------------|---|------|------|------|------|
| I _{CBO} | collector-base cut-off current | V _{CB} = 30 V; I _E = 0 | _ | _ | 100 | nA |
| | | V _{CB} = 30 V; I _E = 0; T _j = 150 °C | _ | _ | 50 | μА |
| I _{EBO} | emitter-base cut-off current | V _{EB} = 5 V; I _C = 0 | _ | _ | 100 | nA |
| h _{FE} | DC current gain | V _{CE} = 2 V; I _C = 500 mA | 300 | 500 | _ | |
| | | V _{CE} = 2 V; I _C = 1 A; note 1 | 300 | 500 | _ | |
| | | V _{CE} = 2 V; I _C = 2 A; note 1 | 250 | 450 | _ | |
| | | $V_{CE} = 2 \text{ V}; I_{C} = 5 \text{ A}; \text{ note 1}$ | 100 | 300 | _ | |
| V _{CEsat} | collector-emitter saturation voltage | $I_C = 500 \text{ mA}; I_B = 5 \text{ mA}$ | - | 50 | 90 | mV |
| | | I _C = 1 A; I _B = 10 mA | - | 75 | 120 | mV |
| | | I _C = 2 A; I _B = 200 mA | - | 90 | 150 | mV |
| | | $I_C = 5 \text{ A}; I_B = 500 \text{ mA}$ | - | 210 | 355 | mV |
| R _{CEsat} | equivalent on-resistance | $I_C = 5 \text{ A}$; $I_B = 500 \text{ mA}$; note 1 | - | 42 | 71 | mΩ |
| V _{BEsat} | base-emitter saturation voltage | I _C = 5 A; I _B = 500 mA | - | 1.1 | 1.3 | V |
| V_{BEon} | base-emitter turn-on voltage | V _{CE} = 2 V; I _C =2 A | - | 0.8 | 1.1 | V |
| f _T | transition frequency | $I_C = 100 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 100 MHz | 70 | 130 | _ | MHz |
| C _c | collector capacitance | $V_{CB} = 10 \text{ V}; I_{E} = I_{e} = 0;$ f = 1 MHz | - | 60 | 75 | pF |

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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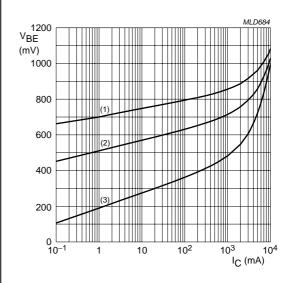
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 $V_{CE} = 2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

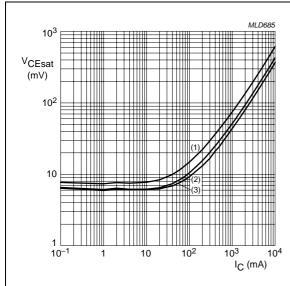
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = 2 V$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

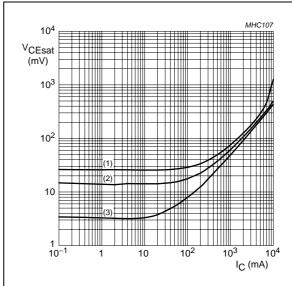
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



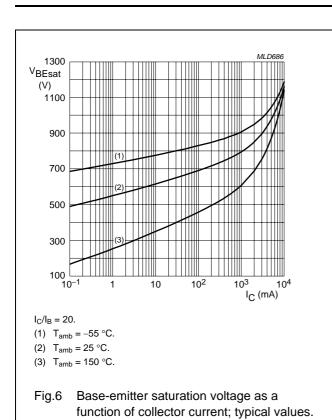
 T_{amb} = 25 °C.

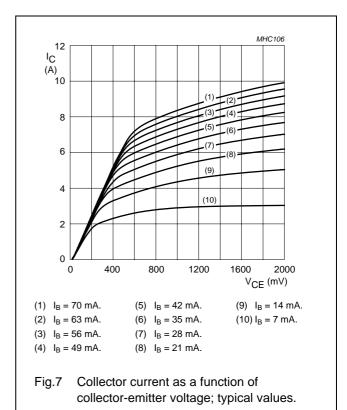
- (1) $I_C/I_B = 100$
- (2) $I_C/I_B = 50$.
- (3) $I_C/I_B = 10$.

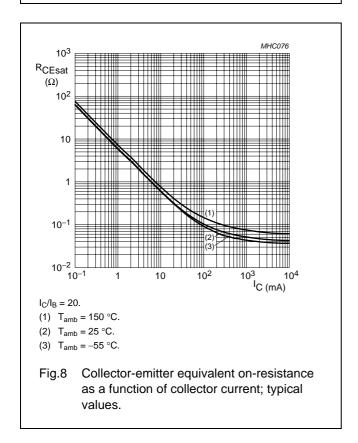
Fig.5 Collector-emitter saturation voltage as a function of collector current; typical values.

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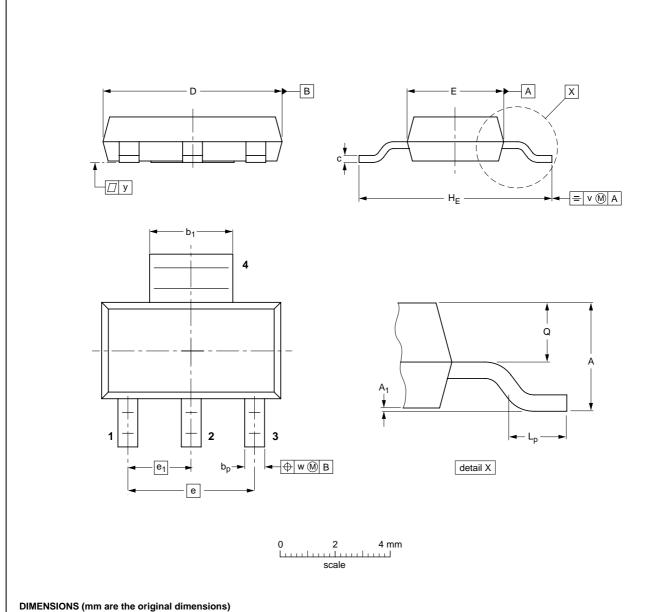
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



| UNI | ТА | , | A ₁ | bp | b ₁ | С | D | E | е | e ₁ | HE | Lp | Q | v | w | у |
|-----|------------|-----|----------------|--------------|----------------|--------------|------------|------------|-----|----------------|------------|------------|--------------|-----|-----|-----|
| mn | 1.8 1.5 | 1 - | .10 | 0.80 0.60 | 3.1 2.9 | 0.32 0.22 | 6.7 6.3 | 3.7 3.3 | 4.6 | 2.3 | 7.3 6.7 | 1.1 0.7 | 0.95 0.85 | 0.2 | 0.1 | 0.1 |

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|---------|-----|-------|----------|------------|------------|----------------------------------|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE |
| SOT223 | | | SC-73 | | | -97-02-28 99-09-13 |

2001 Nov 14 7

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DATA SHEET STATUS

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|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
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| Product data sheet | Production | This document contains the product specification. |

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